

# EE/CprE/SE 492 Bi-WEEKLY REPORT 1

## Digital ASIC Fabrication

8/21/2023 – 9/10/2023

Group number: sddec23-06

Client & Advisor: Dr. Henry Duwe

### Team Members/Role

- Jake Hafele
- Gregory Ling
- Will Galles
- Cade Breedings

### Past Week Assignments

- Meet for first time of semester with Duwe
- Set weekly meeting times with advisor (Duwe)
- Complete SPI verilog and testbenches
- Complete wishbone test
- Get started on other design modules

### Meeting Notes from Previous Week with Dr. Duwe

8/21/23

We are BACK!!

TODO:

1. Find a meeting time for this semester
2. Make sure we are working in the first few weeks before other classes murder us

Meeting Time

- More critical to meet weekly in 491
- Will block out time for weekly meetings, and we can decide if we want to attend

ChatGPT Digital ASIC

MPWShuttle Deadline

- No internal deadline

- Anything that would come back would be at end of semester
- Reported previous project back in November as of today

#### Goals

- Early in semester complete digital design
- Spend later part of semester on bring up plan for our design
  - o Write python script to interface
  - o USB to SPI
- Think about bring up for incoming chip

9/6/23

#### Updates from us

- Wishbone Bus
  - o Gregory got RTL design and testbench run
  - o Jake hardened comm control bus for wishbone/SPI interfaces
- Comm Control
  - o Gregory designed RTL
  - o Jake tested with backdoor SPI testbenches
  - o Same architecture for SPI and wishbone bus
- Backdoor SPI
  - o Got RTL simulations done for backdoor SPI
  - o Coming into roadblocks
- Custom Cell Test
  - o Gregory got magic installed
- Hardening
  - o Will figured out how to get different user modules hardened inside top level user area wrapper
  - o Harden all different modules and route together in top wrapper
  - o Reference as VERILOG\_FILE\_BLACKBOX and include REF and GDL files
  - o Is it worth it to make hardened black boxes or throw all in top level?
  - o For all together:
  - o May take very long
  - o Tools may not be powerful enough
  - o Would save space
  - o Separate black boxes
  - o Will save time
  - o Lower risk (?)

#### Notes

- In final design may not want Logic analyzer fully hooked up, lots of overhead
- Can we use a hardened netlist for signoff?
  - o Get SPEF or SDF files from hardening
  - o What power signoff tools can be used?
- MPW7 has still not been sent to packaging
- Add a CI/CD when pushing design

## TODO

- Gregory work on custom cell in Magic
  - o "I have no idea where this is going to go"
- First biweekly report due next week
- Presentation in lecture next week
- Update Gantt chart to track progress of each module
- Get more experience hardening modules
- Request VM in Dr. Duwes name as owner for hardening
- Add Duwe to Git repo

## Bi-Weekly Progress

- Gregory
  - o Wishbone bus RTL & Testbench written
  - o Comm control RTL & Testbench written
  - o Magic installed and new project created for custom cell design
- Jake
  - o Finished top level backdoor\_spi implementation and testbench
  - o Tested backdoor\_spi with module\_control interface to decode/MUX data from design modules to master SPI
  - o Setup config files for hardening spi module, debugged synthesize errors
  - o Included documentation updates for spi design modules in submodule design folder
- Will
  - o Figured out how to harden both individual modules and combine them in the total project wrapper
  - o Started to setup OpenRAM environment to add in memory to user area.
  - o
- Cade
  - o Getting back into the project, minor updates to my modules

## Individual Contributions

Team Member	Contribution	Hours per report	Total Hours
Jake Hafele	SPI design/testing, hardening	15	75
Gregory Ling	Wishbone bus, Comm control, Magic setup	15	61
Will Galles	Hardening, OpenRAM	15	75
Cade Breeding	Minor updates	3	48

## Plans for Upcoming Two Weeks

- Gregory
  - Design something in Magic
  - Try to schedule a meeting with Maruf Ahamed or Alex Stoytchev to ask about the Magic layout.
  - See about importing a Magic project into Cadence for simulation (Ask Jake)
- Jake
  - Integrate hardened designs of backdoor\_spi and control\_module interfaces
  - Push validated spi design to main
  - Setup config files and SPI integration in main branch of git
  - Create excel spreadsheet to decode data for wishbone/spi for every module
- Will
  - Finish setting up the openRAM environment.
  - Implement a memory bank in the user area.
  - Harden the memory bank.
  - Put together a small test bench to ensure the memory's functionality.
- Cade
  - Push changes and finish standard cell module